PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ching-Chung Ko	10/12/2007
Tao Cheng	10/12/2007
Tien-Yueh Liu	10/12/2007
Dar-Shii Chou	10/12/2007
Peng-Cheng Kao	10/12/2007

RECEIVING PARTY DATA

Name:	MEDIATEK INC.	
Street Address:	No. 1, Dusing Rd. 1st, Science-Based Industrial Park	
City:	Hsin-Chu	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12883163

CORRESPONDENCE DATA

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Total Attachments: 3 source=941018#page1.tif

PATENT REEL: 024995 FRAME: 0325 12883163

ICH \$40,00

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> PATENT REEL: 024995 FRAME: 0326

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name:	Ching-Chung Ko	Nationality:	R.O.C.
Name:	Tao Cheng	Nationality:	R.O.C.
Name:	Tien-Yueh Liu	Nationality:	R.O.C.
Name:	Dar-Shii Chou	Nationality:	R.O.C.
Name:	Peng-Cheng Kao	Nationality:	R.O.C.
Hereby sells, a	ssigns and transfers to		
ASSIGNEE(S) :		
Name:	MEDIATEK INC.		
Address:	ddress: No. 1, Dusing Rd. 1st, Science-Based Industrial Park, Hsin-Chu 300, Taiwan, R.		hu 300, Taiwan, R.O.C.

REEL: 024995 FRAME: 0327

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"POWER AND GROUND ROUTING OF INTEGRATED CIRCUIT DEVICES WITH IMPROVED IR DROP AND CHIP PERFORMANCE"

Which is	s found in :		
(a) <u>+</u>	U.S. patent applic	cation executed on even date	
(b)	U.S. patent applic	cation executed on	
(c)	U.S. application s	erial no	
(d)	patent no.	issued	

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We Is signing). (靖發明人務必簽署上列日期一)	nave hereunto set hand and seal this (Date of
(Type name of inventor)	Signature of INVENTOR
Ching-Chung Ko	Ching-Ching 6 Oct-12, 2007
Tao Cheng	Jao Cheip Oct12, 2007
Tien-Yueh Liu	Tien-York Lin Oct-12, 2007
Dar-Shii Chou	Dar- Shin Chou, Oct 12, 2007
Peng-Cheng Kao	Pong-cheng kao Oct12, 2007

RECORDED: 09/15/2010